i.MX 8M Nano DDR4 EVK Board Hardware User's Guide

1. Introduction

This document is the hardware User's Guide for the i.MX 8M Nano DDR4 Evaluation Kit (EVK) based on the NXP Semiconductor's i.MX 8M Nano Applications Processor. This board is fully supported by NXP Semiconductor. This manual includes system setup and configurations, and provides detailed information on the overall design and usage of the EVK board from a hardware system perspective.

1.1. Board overview

The DDR4 EVK board is a platform designed to show the most commonly used features of the i.MX 8M Nano Applications Processor. The i.MX 8M Nano DDR4 EVK board helps developers get familiar with the processor before investing a large amount of resources in more specific designs.

Table 1 lists the features of the i.MX 8M Nano DDR4 EVK board.

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Table 1. Board features

Processor	NXP Applications Processor	MIMX8MN6DVTJZAA	
DRAM memory	Micron 2 GB DDR4	MT40A1G16RC-062E:B	
Mass storage	SanDisk 16 GB eMMC5.1	SDINBDG4-16G-I1	
	Micron 32 MB QSPI NOR	MT25QU256ABA1EW7-0SIT	
	MicroSD card connector	SD3.0 supported	
Power	ROHM PMIC BD71850 + Discrete DCDC	/LDO	
Camera	CSI interface (Mini-SAS connector)		
Display interface	DSI interface (Mini-SAS connector)		
Ethernet	1 GB Ethernet with RJ45 connector		
USB	Port1 is USB (2.0) Type-C connector, Port2 is used as the Power Input		
Wi-Fi/Bluetooth	x1 on board Wi-Fi/Bluetooth module, 802.11a/b/g/n/ac, BT5.0		
Audio connectors	3.5 mm Stereo Line output, 2Vrms		
Audio connectors	FPC connector (SAI ports) for Audio Card		
Debug connectors	JTAG (10pin header)		
Debug connectors	MicroUSB for UART debug, two COM Ports for A53 and M7		
Expansion connector	40-pin dual-row Pin Header for I2S, UART, I2C and GPIO expansion		
I2C connector	8-pin dual-row Pin Header for I ² C expansion		
Buttons	ON/OFF, RESET		
LED indicators	Power status, UART		
РСВ	8MNANOD4-CPU: 2inch x 2inch, 6-layer		
РСВ	8MMINI-BB: 4inch x 4.2inch, 8-layer		
Orderable part number	8MNANOD4-EVK		
Orderable part fluifiber	*consists of 8MNANOD4-CPU plus 8MMINI-BB, boards not orderable separately		

1.2. Board contents

The i.MX 8M Nano DDR4 EVK contains the following items:

- i.MX 8M Nano DDR4 EVK board, assembled by two separate boards, 8MNANOD4-CPU (SOM Board) and 8MMINI-BB (Base Board)
- IMX-MIPI-HDMI Accessory Card, MIPI-DSI to HDMI adapter board
- USB Type-C 45W Power Delivery Supply, 5V/3A, 9V/3A, 15V/3A, 20V/2.25A supported
- Mini-SAS cable, 8" mini-SAS cable
- USB Type-C Cable, Cable Assembly, USB 3.0, Type-C Male to Type-A Male
- USB micro-B Cable, Cable Assembly, USB 2.0, Type-A Male to Micro-B Male
- USB Type-C to A Adapter, Adapter USB 3.0, Type-C Male to Type-A Female
- Quick Start Guide

2. Specifications

This section provides the detailed information about the electrical design and practical considerations on the DDR4 EVK board. **Figure 1** describes each block in the high-level block diagram of the DDR4 EVK board.

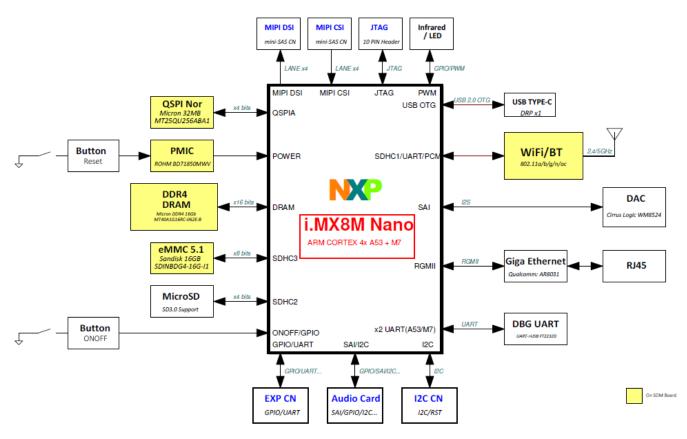


Figure 1. i.MX 8M Nano DDR4 EVK Block Diagram

Figure 2 shows the overview of the i.MX 8M Nano DDR4 EVK board.

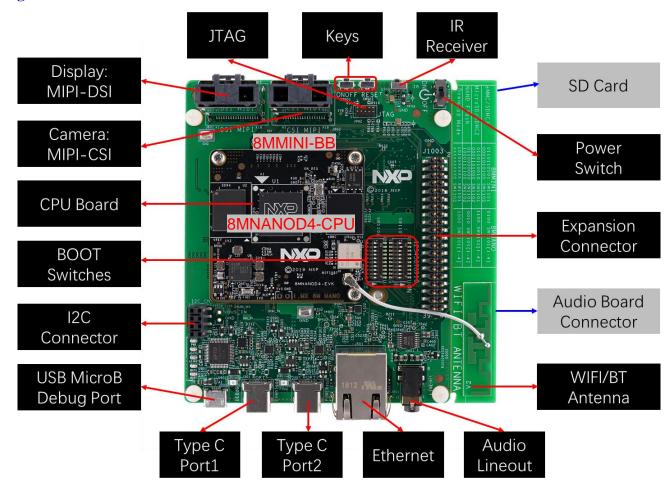


Figure 2. i.MX 8M Nano DDR4 EVK board overview

CAUTION

Type-C Port2 is the only power supply port, and it must be always supplied for system running.

i.MX 8M Nano EVK is not a typical use case of the PD device. It is supplied by the PD charger only, but with a power switch. When the switch keeps OFF for more than 5.5 seconds after adapting the PD charger, the charger (Source) will repower EVK (Sink) after the system initiates the PD software. See Section 6.5.7 in the *Universal Serial Bus Power Delivery Specification Revision 2.0*. There are two ways to avoid repower:

- The power switch must always be in the **ON** position before attaching the PD charger.
- Change the software to disable the PD function, and make it Type-C supply only.

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3. Processor

The i.MX 8M Nano applications processors represent NXP Semiconductor's latest achievement in highly integrated multimedia-focused products offering high performance processing. These applications processors can enable the growing market of smart, secure, connected devices. The i.MX 8M Nano applications processors feature NXP's advanced implementation of the Quad Arm Cortex®-A53+ Arm Cortex®-M7 cores, which operate at speeds up to 1.5 GHz and 650 MHz respectively. Each i.MX 8M Nano device provides a 16-bit DDR3L/DDR4/LPDDR4 memory interface and other interfaces for connecting peripherals, such as MIPI LCD, MIPI Camera, WLAN, BluetoothTM, Ethernet, Digital Mic, and multi-sensors.

For more detailed information about the processor, see the datasheet and reference manual on www.nxp.com/i.MX8MNANO.

3.1. Boot Mode and Boot Device configurations

The i.MX 8M Nano implement a compressed boot mode decode with four BOOT_MODE pins. It can boot from the boot configuration selected on SW1101 or from the boot configuration stored on the internal eFUSE. In addition, the i.MX 8M Nano can download a program image from a USB connection when configured in serial downloader mode. The method used to determine where the processor finds its boot information is from four dedicated BOOT MODE pins.

On the i.MX 8M Nano DDR4 EVK board, the default boot mode is to boot from the eMMC device. There are two additional boot devices; a QSPI Nor Flash on the CPU board, and a MicroSD connector on the Base Board. If you set the boot device to QSPI or MicroSD, the board will boot from the device accordingly.

Table 2 shows the values used for boot selection.

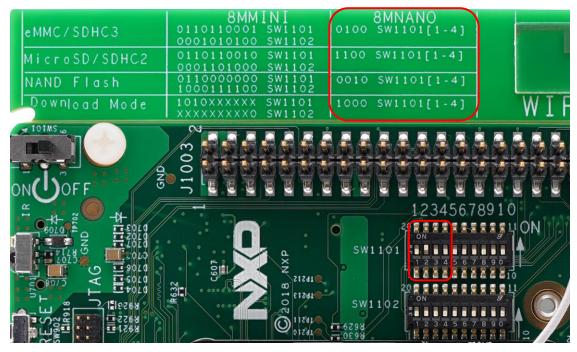


Figure 3. Boot Selection

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Table 2. Boot selection

BOOT_MODE3	BOOT_MODE2	BOOT_MODE1	BOOT_MODE0	Boot Device
(SW1101 pin4)	(SW1101 pin3)	(SW1101 pin2)	(SW1101 pin1)	
0	0	0	0	Boot from fuses
0	0	0	1	Serial downloader
0	0	1	0	eMMC/uSDHC3
0	0	1	1	MicroSD/uSDHC2
0	1	0	0	NAND Flash
0	1	1	0	QSPI 3B Read
0	1	1	1	QSPI Hyperflash 3.3V
1	0	0	0	ecSPI Boot

NOTE

Only SW1101[1-4] are used for boot selection, the left pins of SW1101 and SW1102 are useless for i.MX 8M Nano, either 0 or 1 is acceptable.

3.2. Power Tree

There is a Type-C power supply that needs to be connected to the i.MX 8M Nano DDR4 EVK board at connector J302. The other powers on the EVK board are generated from PMIC and discrete devices to supply the whole system. **Figure 4** shows the Power Tree.

PMIC: BD71850 CPU: i.MX8M Nano Max Capability(mA) Required(mA) TYP SEQ PWR/Signal REG LDO1 LDO2 RTC_RESET_B RTC_CLK BUCK1 BUCK2 LDO3 BUCK7 BUCK8 BUCK6 MUXSW LDO6 POR_B NVCC_SNVS_1V8 VDD_SNVS_0V8 RTC_RESET_B CLK_32K_0UT VDD_SOC&DRAM&PU_0V9 VDD_ARM_0V9 VDDA_1V8 VCC_DRAM_1V2 NVCC_SV3 NVCC_SV3 VDD_SVS_VCC_SV3 NVCC_SV3 1.8 0.8 10 10 3 4 5 6 6 7 8 9 10 11 0.85/0.95 0.85/0.95/1.0 1.8 1.8 1.2 3.3 3.3/1.8 3000 3000 300 1500 3000 3000 150 300 NxCxVx(0.5xF) NxCxVx(0.5xF) 100 10 LPDDR4 VDDEXT_3V3 3.3V/4A QSPI VCC eMMC VDD_5V 5V/3A WiFi/BT Audio DAC mini-SAS (MIPI CSI/DSI) M.2 PCle USB TYPE-C

8MNANOD4-EVK PWR TREE

Figure 4. Power Tree Diagram

In **Figure 4**, the developer can get all the voltage supply rails used on the EVK board. When some modules are not enabled, the power supplies might be shut down by software. **Table 3** lists the power rails on the board.

Table 3.	Power	rails
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SEQ	Power Rail	Regulator	Value/V
0 DCDC_5V		Discrete	5
1	NVCC_SNVS_1V8	BD71850 LDO1	1.8
2	VDD_SNVS_0V8	BD71850 LDO2	0.8
3	RTC_RESET_B	BD71850	-
4	CLK_32K_OUT	BD71850	-
5	VDD_SOC_DRAM_PU_0V9	BD71850 BUCK1	0.85/0.95 ¹
6	VDD_ARM_0V9	BD71850 BUCK2	0.85/0.95/1.0 ²
6	VDDA_1V8	BD71850 LDO3	1.8
7	VDD_1V8/NVCC_1V8	BD71850 BUCK7	1.8
8	NVCC_DRAM_1V2	BD71850 BUCK8	1.2 ³
9	VDD_3V3/NVCC_3V3	BD71850 BUCK6	3.3
9	NVCC_SD2	BD71850 MUXSW	3.3/1.8
9	VDD_5V	Load Switch	5
9	VDDEXT_3V3	Discrete	3.3
10	VDD_PHY_1V2	BD71850 LDO6	1.2
11	POR_B	BD71850	-
12 VSD_3V3		Load Switch	3.3

^{1.} BD71850 BUCK1 default output voltage is 0.8 V. Software will change it to 0.85 V for nominal mode, 0.95 V for overdrive mode in SPL before DDR initialization.

3.3. DDR4 DRAM memory

The i.MX 8M Nano DDR4 EVK board has one <u>1G x 16 (1 channel x 16 I/O)</u> DDR4 SDRAM chip (MT40A1G16RC-062E:B) for a total of 2 GB RAM memory.

In the physical layout, the DDR4 chip is placed on the TOP side, the data traces are not necessarily connected to the DDR4 chips in sequential order, but for ease of routing, are connected as best determined by the layout and other critical traces.

The DRAM_VREF can be generated by i.MX 8M Nano internally, so it does not need to use external power supply and decoupling capacitors. The calibration resistors used by the DDR4 chips and processor are 240 Ohm 1 % resistors. The differential termination resistors for DRAM Clock are two 43 ohm 1 % with one 0.22 uF capacitance on EVK. Developers can change this value depending on simulation and test result.

^{2.} BD71850 BUCK2 default output voltage is 0.9 V. Software will change it to 0.85 V for 1.2 GHz operation, 0.95 V for 1.4 GHz, 1.0 V for 1.5 GHz.

^{3.} BD71850 BUCK8 default output voltage is 1.1 V. Software will change it to 1.2 V in SPL before DDR initialization.

3.4. eMMC memory (U4)

The eMMC memory is connected to the uSDHC3 interface of i.MX 8M Nano, and it can support up to eMMC 5.1 device. The eMMC memory is on the 8MNANOD4-CPU board, and the part number is SDINBDG4-16G-I1. It is the default boot device of the EVK. The boot settings are as shown in **Table 2**.

3.5. QSPI Nor Flash (U5)

The QSPI memory is connected to the FlexSPI interface of i.MX 8M Nano, and it can support up to 166 MHz DDR mode device. The QSPI memory is on the 8MNANOPD4-CPU board, and the part number is MT25QU256ABA1EW7-0SIT. To select it as the boot device of the EVK, developers can refer to the boot settings as shown in **Table 2**.

3.6. SD card slot (J701)

There is one MicroSD card slot (J701) on the 8MMINI-BB board, connecting to the uSDHC2 interface of i.MX 8M Nano. This connector supports one 4-bit SD3.0 MicroSD card. To select it as the boot device of the EVK, developers can refer to the boot settings as shown in **Table 2**.

3.7. MIPI-CSI and MIPI-DSI connectors (J802, J801)

The i.MX 8M Nano processor supports one 4-lane MIPI-CSI and one 4-lane MIPI-DSI. The MiniSAS connectors are designed to support camera and LCD with dedicated pin definition. The connectors are as shown in **Figure 2**. Display and camera accessory boards are available separately. The full list can be found at www.nxp.com/i.MX8-ACCESSORY-BOARDS.

3.8. Ethernet connector (J501)

The Ethernet subsystem of the EVK board is provided by the Qualcomm AR8031 Ethernet Transceiver (U501). The Ethernet Transceiver (or PHY) receives standard RGMII Ethernet signals from the MAC-NET core of the i.MX 8M Nano. The processor handles all Ethernet protocols at the MAC layer and above. The PHY is only responsible for the Link Layer formatting. The Ethernet connector (J501) integrates Magnetic transformer inside, so it cannot be directly connected to AR8031 (U501).

Each EVK board has a unique MAC address, which is burned into i.MX 8M Nano by Fuse. A label with the unique MAC address is placed on the connector for reference.

3.9. USB connector (J301, J302)

The i.MX 8M Nano Applications Processors contain one USB 2.0 OTG controller, with one integrated USB PHY. There are two USB Type-C connectors on the EVK board, but only Port1 can support Host and Device Mode.

J301 is connected to USB1 interface of i.MX 8M Nano, which can act as the download port of the EVK.

J302 is the power supply port of the EVK.

3.10. Wi-Fi/Bluetooth (U6)

The EVK board has a Wi-Fi/Bluetooth module LBEE5HY1MW on the 8MNANOD4-CPU board. The module is Cypress CYW43455 based, contains SDIO3.0, UART, PCM interface, and can support 802.11a/b/g/n/ac, BT5.0. The 2.4G/5G antenna is stuck to the edge of the Base Board with a coaxial cable connected to the CPU Board.

3.11. Audio Line output (J401)

The EVK board uses a high-quality Stereo DAC WM8524 (U401), which can support 24 bit I2S data and 192 KHz sampling rate. The Line output of WM8524 is **2Vrms**, not like common headphone output 1 Vrms. Developers must be very careful about this interface. The Line output connector (J401) is a 3.5 mm 4-pole (or TRRS) phone jack.

CAUTION

The Audio Line output connector is designed for active speaker with a power amplifier. To connect it with a headphone, make sure that the headphone has volume control functionality and set the headphone's volume properly before wearing it. Do not plug in the non-volume-control headphone directly. The audio output volume may be too high for non-volume-control headphone and may damage it.

3.12. Audio Card connector (J1001)

One 60-pin FPC connector (J1001) is provided on the EVK board to support audio card connection, and the developers can use the audio card to perform audio features development.

CAUTION

There is no SAI1 from the i.MX 8M Nano process, so AK4458/ AK4497 can't be enabled on audio card.

3.13. JTAG connector (J902)

The i.MX 8M Nano Applications Processor has four JATG signals on dedicated pins, and one HW reset input signal POR_B. Those signals are directly connected to the 10-pin 1.27 mm JTAG connector J902. The four JTAG signals used by the processor are:

JTAG_TCK TAP Clock

• JTAG TMS TAP Machine State

• JTAG_TDI TAP Data In

• JTAG_TDO TAP Data Out

3.14. USB-UART connector (J901)

The i.MX 8M Nano Applications Processor has four independent UART Ports (UART1 – UART4). On the EVK board, UART2 is used for Cortex-A53 core, and UART4 is used for Cortex-M7 core. We use a Single chip USB to dual channel UART IC for system debugging, and the part number is FT2232D. The developers can download the driver from FTDI website http://www.ftdichip.com/Drivers/VCP.htm. After the driver for FT2232D is installed, the PC will enumerate two COM ports when the USB cable is plugged into J901. Developers can use Putty, Tera Term, Xshell, or other terminal tools. The required settings are as listed in **Table 4**.

Table 4. Terminal setting parameters

Data Rate	115,200 Baud	
Data bits	8	
Parity	None	
Stop bits	1	

3.15. Expansion connector (J1003)

One 40-pin dual-row Pin Header connector (J1003) is provided on the EVK board to support I2S, UART, I2C, and GPIO connection. The developers can use the port for some specific application development.

Table 5. J1003 Pin Definition

Num	Net Name	Description	Num	Net Name	Description
1	VEXT_3V3	Power Output, 3.3V	2	VDD_5V	Power Output, 5V
3	I2C3_SDA_3V3	I2C3 data signal	4	VDD_5V	Power Output, 5V
5	I2C3_SCL_3V3	I2C3 clock signal	6	GND	Ground
7	UART3_CTS	UART3 clear to send signal	8	UART3_TXD	UART3 transmit signal
9	GND	Ground	10	UART3_RXD	UART3 transmit signal
11	UART3_RTS	UART3 request to send signal	12	EXP_IO8	Expansion IO signal
13	EXP_IO9	Expansion IO signal	14	GND	Ground
15	EXP_IO10	Expansion IO signal	16	EXP_IO11	Expansion IO signal
17	VEXT_3V3	Power Output, 3.3V	18	-	NC
19	ECSPI2_MOSI	SPI2 data signal, master	20	GND	Ground
		output slave input			
21	ECSPI2_MISO	SPI2 data signal, master input	22	-	NC
		slave output			
23	ECSPI2_SCLK	SPI2 clock signal	24	ECSPI2_SS0	SPI2 chip select signal
25	GND	Ground	26	-	NC
27	-	NC	28	-	NC
29	-	NC	30	GND	Ground
31	EXP_IO14	Expansion IO signal	32	EXP_IO12	Expansion IO signal
33	EXP_IO13	Expansion IO signal	34	GND	Ground
35	SAI5_RXD3	SAI5 receive data signal	36	SAI5_RXD2	SAI5 receive data signal
37	SAI5_RXD1	SAI5 receive data signal	38	SAI5_RXD0	SAI5 receive data signal
39	GND	Ground	40	SAI5_RXC	SAI5 receive clock signal

3.16. I2C connector (J1004)

One 8-pin dual-row Pin Header connector (J1004) is provided on the EVK board to support I²C connection. The developers can use the port for some specific application development.

 Num
 Net Name
 Description

 1/2
 VDD_3V3
 Power Output, 3.3V

 3/4
 I2C3_SCL_3V3
 I2C clock signal

 5/6
 I2C3_SDA_3V3
 I2C data signal

 7/8
 GND
 Ground

Table 6. J1004 Pin Definition

3.17. User interface buttons

There are two user interface buttons on the EVK board.

3.17.1. Power button (SW901)

The i.MX 8M Nano Applications Processor supports the use of a button input signal to request main SoC power state changes (i.e. ON or OFF) from the PMU.

The ON/OFF button can be used for debounce, OFF-to-ON time, and max timeout. Debounce is used to generate the power-off interrupt. In the ON state, if ON/OFF button is held longer than the debounce time, the power-off interrupt is generated. In the OFF state, if the ON/OFF button is held longer than the OFF-to-ON time, the state will transit from OFF to ON. Max timeout can also be the time for requesting physical power down after the ON/OFF button has been held for the defined time.

3.17.2. Reset button (SW902)

The RESET button (SW902) is directly connected to the PMIC BD71850. Holding the RESET button will force to reset the PMIC power outputs except NVCC_SNVS_1V8 and VDD_SNVS_0V8 on the EVK board. The i.MX 8M Nano applications processor will be immediately turned off and reinitiate a boot cycle from the OFF state.

3.18. User interface LED indicators

There are four LED indicators on the board. These LEDs have the following functions:

- Main Power Supply (D708)
 - Green The board is powered on.
 - OFF The board is powered off.
- System Status (D1) on 8MNANOD4-CPU
 - Green Blinking CPU is running well.
 - OFF CPU is not running.

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- M7 UART (D902/D903)
 - D902 Green light flashing The UART data transmitted to PC.
 - D903 Orange light flashing The UART data received from PC.
- A53 UART (D906/D905)
 - D906 Green light flashing The UART data transmitted to PC.
 - D905 Orange light flashing The UART data received from PC.

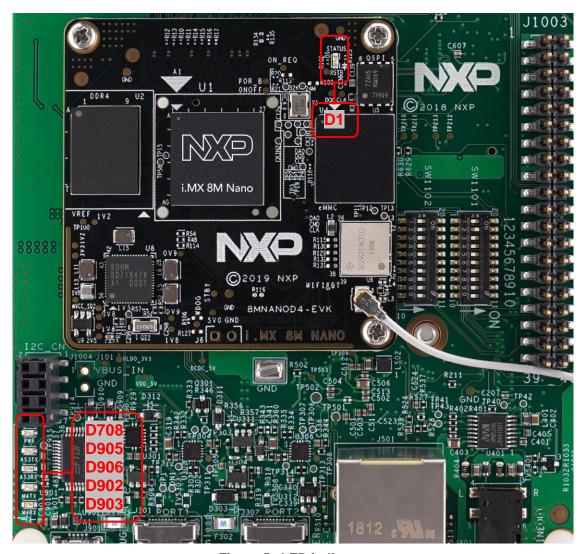


Figure 5. LED indicator

4. PCB information

The i.MX 8M Nano DDR4 EVK is composed by 8MNANOD4-CPU and 8MMINI-BB. **Table 1** lists the dimensions of the two boards. Both the two boards are made with standard 8-layer technology. The material is FR-4, and the PCB stack-up information is shown in **Table 7** and **Table 8**.

Table 7. 8MNANOD4-CPU Board stack up information

Layer	Description	Coppoer (Oz.)	Dielectric thickness (mil)
1	Signal	0.5+Plating	
	Dielectric		2.76 mil
2	GND	1	
	Dielectric		2.95 mil
3	Signal	1	
	Dielectric		25.28 mil
5	Power	1	
	Dielectric		2.95 mil
6	Power	1	
	Dielectric		2.76 mil
8	Signal	0.5+Plating	
	-		
Total thickness:	47.24(4.72/	/-4.72) mil	1.2(+0.12/-0.12) MM
Material:	TU768		TU768

Table 8. 8MMINI-BB Board stack up information

Layer	Description	Coppoer (Oz.)	Dielectric thickness (mil)
1	Signal	0.5+Plating	
	Dielectric		2.717 mil
2	GND	1	
	Dielectric		4.33 mil
3	Signal	1	
	Dielectric		11.085 mil
4	Power	1	
	Dielectric		14.170 mil
5	Power	1	
	Dielectric		11.415 mil
6	Signal	1	
	Dielectric		4.33 mil
7	GND	1	
	Dielectric		2.717 mil
8	Signal	0.5+Plating	
Total thickness:	62.992(6.299	/-6.299) mil	1.6(+0.16/-0.16) MM
Material:	TU768		TU768

4.1. EVK design files

You can download the schematics, layout files, gerber files, and BOM from www.nxp.com/imx8mnanoevk.

5. Revision history

Table 9. Revision history

Revision number	Date	Substantive changes
0	12/2019	Initial release.

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